- **Meets or Exceeds the Requirements of ANSI Standard EIA/TIA-232-E and ITU Recommendation V.28**
- **Input Resistance . . . 3 kΩ to 7 kΩ Over Full EIA/TIA-232-E Voltage Range**
- **Input Threshold Adjustable to Meet Fail-Safe Requirements Without Using External Components**
- **Built-In Hysteresis for Increased Noise Immunity**
- **Inverting Output Compatible With TTL**
- **Output With Active Pullup for Symmetrical Switching Speeds**
- **Standard Supply Voltages . . . 5 V or 12 V**

D OR N PACKAGE
(TOP VIEW)

```
        _____
3T  [ 1      16 ]  V_CC2
2T  [ 2      15 ]  V_CC1
1T  [ 3      14 ]  4T
1A  [ 4      13 ]  1Y
2A  [ 5      12 ]  2Y
3A  [ 6      11 ]  3Y
4A  [ 7      10 ]  4Y
GND [ 8       9 ]  R1†
```
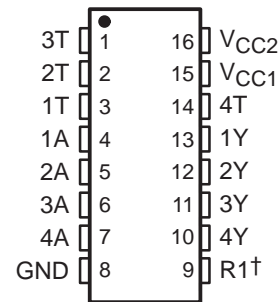
† For function of R1, see schematic

description

The SN75154 is a monolithic low-power Schottky line receiver designed to satisfy the requirements of the standard interface between data terminal equipment and data communication equipment as defined by ANSI Standard EIA/TIA-232-E. Other applications are for relatively short, single-line, point-to-point data transmission and for level translators. Operation is normally from a single 5-V supply; however, a built-in option allows operation from a 12-V supply without the use of additional components. The output is compatible with most TTL circuits when either supply voltage is used.

In normal operation, the threshold-control terminals are connected to the V_{CC1} terminal, even if power is being supplied via the alternate V_{CC2} terminal. This provides a wide hysteresis loop, which is the difference between the positive-going and negative-going threshold voltages. See typical characteristics. In this mode of operation, if the input voltage goes to zero, the output voltage will remain at the low or high level as determined by the previous input.

For fail-safe operation, the threshold-control terminals are open. This reduces the hysteresis loop by causing the negative-going threshold voltage to be above zero. The positive-going threshold voltage remains above zero as it is unaffected by the disposition of the threshold terminals. In the fail-safe mode, if the input voltage goes to zero or an open-circuit condition, the output will go to the high level regardless of the previous input condition.

The SN75154 is characterized for operation from 0°C to 70°C.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

TEXAS INSTRUMENTS

SN75154
QUADRUPLE LINE RECEIVER
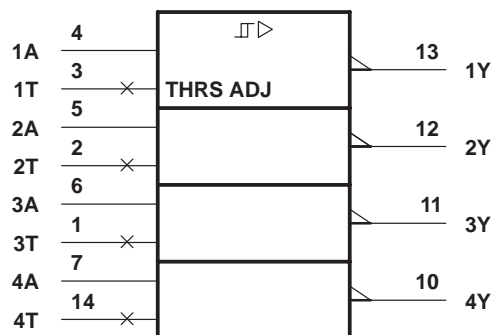
logic symbol[†]

logic diagram (positive logic)
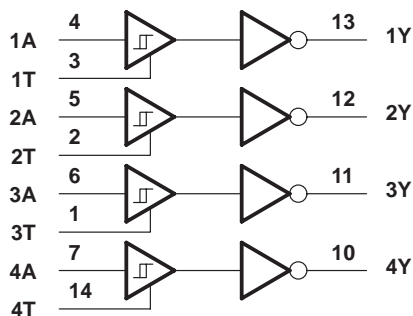
[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

schematic

Component values shown are nominal.

⏚ . . . Substrate

[‡] When V_{CC1} is used, V_{CC2} may be left open or shorted to V_{CC1}. When V_{CC2} is used, V_{CC1} must be left open or connected to the threshold control pins.

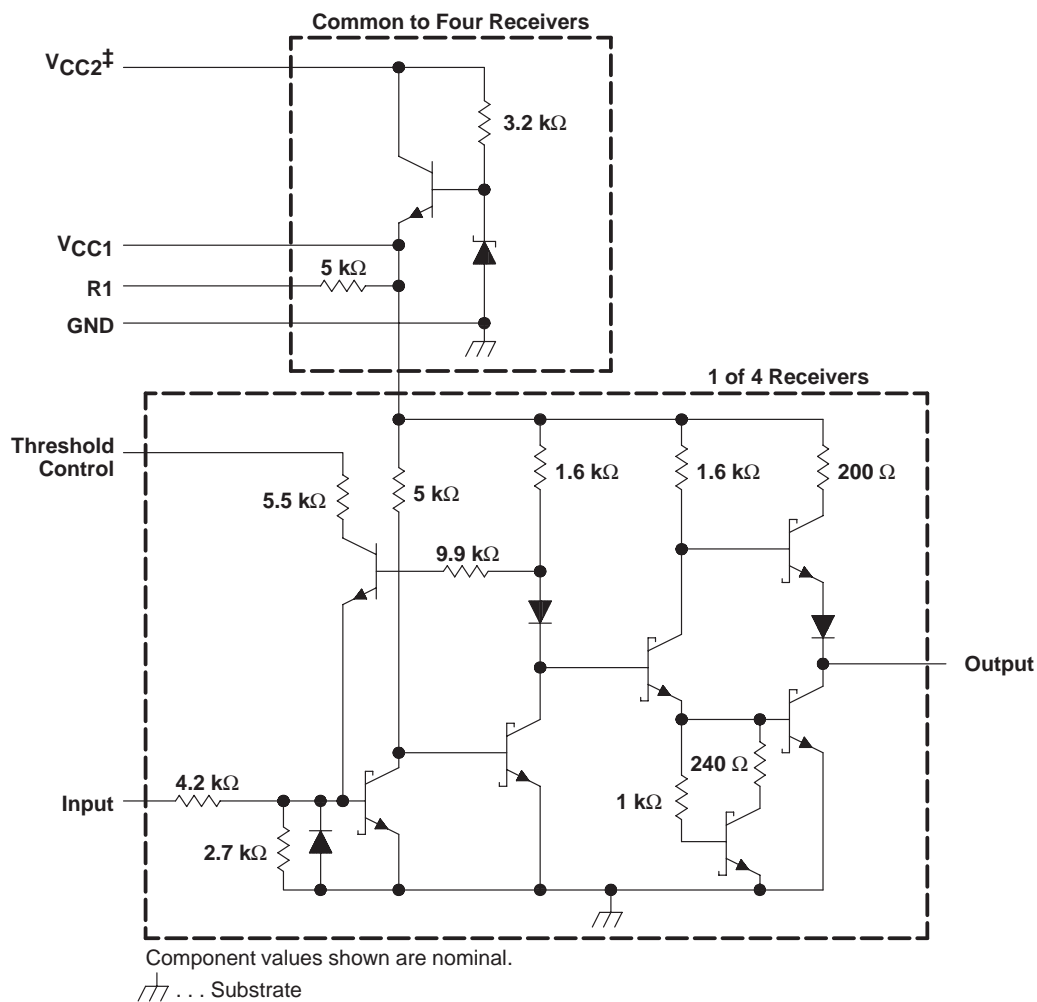## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Normal supply voltage, V_{CC1} (see Note 1)	7 V
Alternate supply voltage, V_{CC2}	14 V
Input voltage, V_I	±25 V
Continuous total power dissipation	See Dissipation Rating Table
Operating free-air temperature range, T_A	0°C to 70°C
Storage temperature range, T_{stg}	−65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1:   Voltage values are with respect to network GND terminal.

DISSIPATION RATING TABLE

PACKAGE	$T_A \leq 25°C$ POWER RATING	DERATING FACTOR ABOVE $T_A = 25°C$	$T_A = 70°C$ POWER RATING
D	950 mW	7.6 mW/°C	608 mW
N	1150 mW	9.2 mW/°C	736 mW
NS	625 mW	5.0 mW/°C	400 mW

recommended operating conditions

	MIN	NOM	MAX	UNIT
Normal supply voltage, V_{CC1}	4.5	5	5.5	V
Alternate supply voltage, V_{CC2}	10.8	12	13.2	V
High-level input voltage, V_{IH} (see Note 2)	3		15	V
Low-level input voltage, V_{IL} (see Note 2)	−15		−3	V
High-level output current, I_{OH}			−400	µA
Low-level output current, I_{OL}			16	mA
Operating free-air temperature, T_A	0		70	°C

NOTE 2:   The algebraic convention, where the less positive (more negative) limit is designated as minimum, is used in this data sheet for logic and threshold levels only, e.g., when 0 V is the maximum, the minimum limit is a more negative voltage.

TEXAS INSTRUMENTS

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER			TEST FIGURE	TEST CONDITIONS		MIN	TYP†	MAX	UNIT
V_{IT+}	Positive-going input threshold voltage	Normal operation	1			0.8	2.2	3	V
		Fail-safe operation				0.8	2.2	3	
V_{IT-}	Negative-going input threshold voltage	Normal operation	1			−3	−1.1	0	V
		Fail-safe operation				0.8	1.4	3	
V_{hys}	Hysteresis voltage ($V_{IT+} - V_{IT-}$)	Normal operation	1			0.8	3.3	6	V
		Fail-safe operation				0	0.8	2.2	
V_{OH}	High-level output voltage		1	$I_{OH} = -400\ \mu A$		2.4	3.5		V
V_{OL}	Low-level output voltage		1	$I_{OL} = 16$ mA			0.29	0.4	V
r_i	Input resistance		2	$\Delta V_I = -25$ V to -14 V		3	5	7	kΩ
				$\Delta V_I = -14$ V to -3 V		3	5	7	
				$\Delta V_I = -3$ V to 3 V		3	6	8	
				$\Delta V_I = 3$ V to 14 V		3	5	7	
				$\Delta V_I = 14$ V to 25 V		3	5	7	
$V_{I(open)}$	Open-circuit input voltage		3	$I_I = 0$		0	0.2	2	V
I_{OS}	Short-circuit output current‡		4	$V_{CC1} = 5.5$ V,	$V_I = -5$ V	−10	−20	−40	mA
I_{CC1}	Supply current from V_{CC1}		5	$V_{CC1} = 5.5$ V,	$T_A = 25°C$		20	35	mA
I_{CC2}	Supply current from V_{CC2}			$V_{CC2} = 13.2$ V,	$T_A = 25°C$		23	40	

† All typical values are at $V_{CC1} = 5$ V, $T_A = 25°C$.
‡ Not more than one output should be shorted at a time.

switching characteristics, V_{CC1} = 5 V, T_A = 25°C, N = 10

PARAMETER		TEST FIGURE	TEST CONDITIONS		MIN	TYP	MAX	UNIT
t_{PLH}	Propagation delay time, low- to high-level output	6	$C_L = 50$ pF,	$R_L = 390\ \Omega$		11		ns
t_{PHL}	Propagation delay time, high- to low-level output					8		ns
t_{TLH}	Transition time, low- to high-level output					7		ns
t_{THL}	Transition time, high- to low-level output					2.2		ns

TYPICAL CHARACTERISTICS

OUTPUT VOLTAGE
vs
INPUT VOLTAGE
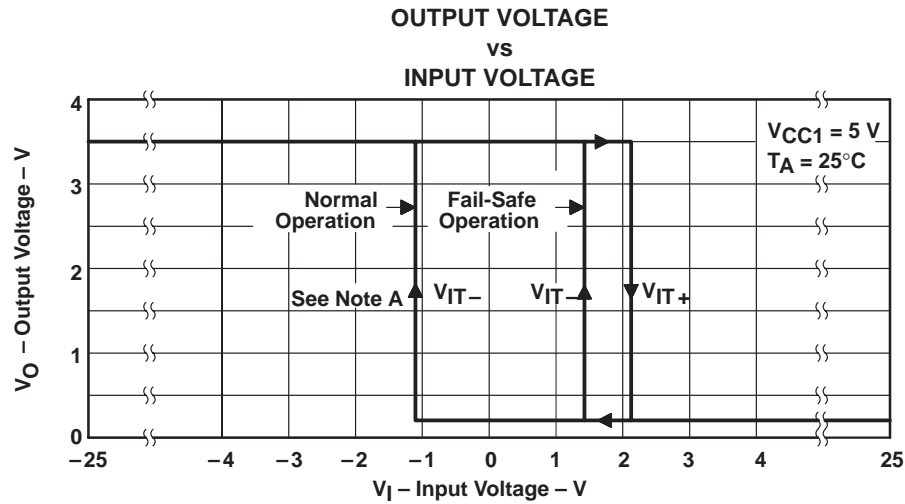
NOTE A: For normal operation, the threshold controls are connected to V_{CC1}. For fail-safe operation, the threshold controls are open.

Figure 1

PARAMETER MEASUREMENT INFORMATION

dc test circuits†

TEST TABLE

TEST	MEASURE	A	T	Y	V_{CC1}	V_{CC2}
Open-circuit input (fail safe)	V_{OH}	Open	Open	I_{OH}	4.5 V	Open
	V_{OH}	Open	Open	I_{OH}	Open	10.8 V
V_{IT+} min, V_{IT-} min (fail safe)	V_{OH}	0.8 V	Open	I_{OH}	5.5 V	Open
	V_{OH}	0.8 V	Open	I_{OH}	Open	13.2 V
V_{IT+} min (normal)	V_{OH}	Note A	V_{CC1}	I_{OH}	5.5 V and T	Open
	V_{OH}	Note A	V_{CC1}	I_{OH}	T	13.2 V
V_{IL} max, V_{IT+} min (normal)	V_{OH}	−3 V	V_{CC1}	I_{OH}	5.5 V and T	Open
	V_{OH}	−3 V	V_{CC1}	I_{OH}	T	13.2 V
V_{IH} min, V_{IT+} max, V_{IT-} max (fail safe)	V_{OL}	3 V	Open	I_{OL}	4.5 V	Open
	V_{OL}	3 V	Open	I_{OL}	Open	10.8 V
V_{IH} min, V_{IT+} max (normal)	V_{OL}	3 V	V_{CC1}	I_{OL}	4.5 V and T	Open
	V_{OL}	3 V	V_{CC1}	I_{OL}	T	10.8 V
V_{IT-} max (normal)	V_{OL}	Note B	V_{CC1}	I_{OL}	5.5 V and T	Open
	V_{OL}	Note B	V_{CC1}	I_{OL}	T	13.2 V

NOTES: A. Momentarily apply −5 V, then 0.8 V.
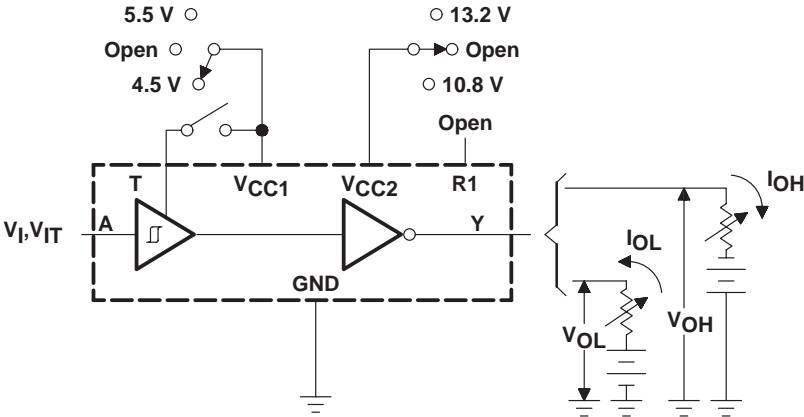B. Momentarily apply 5 V, then GND.

Figure 2. V_{IH}, V_{IL}, V_{IT+}, V_{IT-}, V_{OH}, V_{OL}

† Arrows indicate actual direction of current flow. Current into a terminal is a positive value.

PARAMETER MEASUREMENT INFORMATION
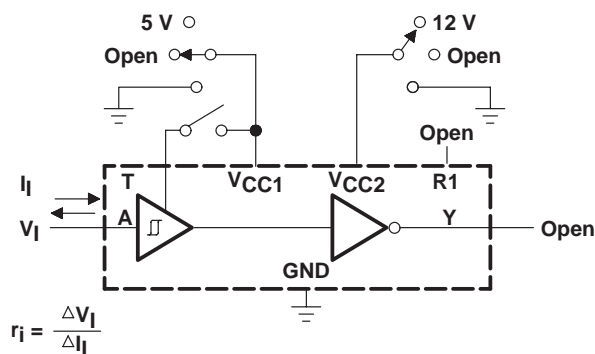
dc test circuits† (continued)

TEST TABLE

T	V_{CC1}	V_{CC2}
Open	5 V	Open
Open	GND	Open
Open	Open	Open
V_{CC1}	T and 5 V	Open
GND	GND	Open
Open	Open	12 V
Open	Open	GND
V_{CC1}	T	12 V
V_{CC1}	T	GND
V_{CC1}	T	Open

$$r_i = \frac{\Delta V_I}{\Delta I_I}$$

Figure 3. Input Resistance

TEST TABLE

T	V_{CC1}	V_{CC2}
Open	5.5 V	Open
V_{CC1}	5.5 V	Open
Open	Open	13.2 V
V_{CC1}	T	13.2 V
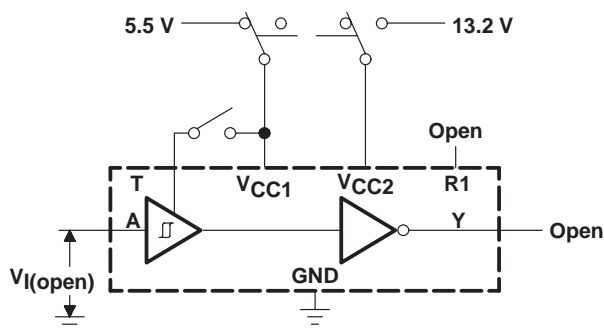
Figure 4. Input Voltage (Open)
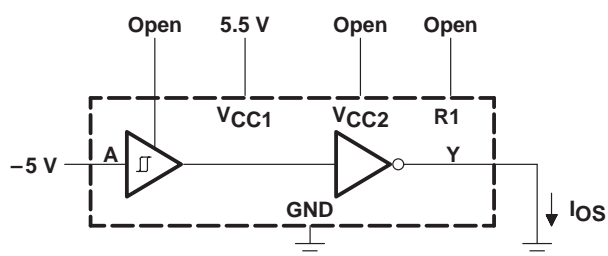
Each output is tested separately.

Figure 5. Output Short-Circuit Current
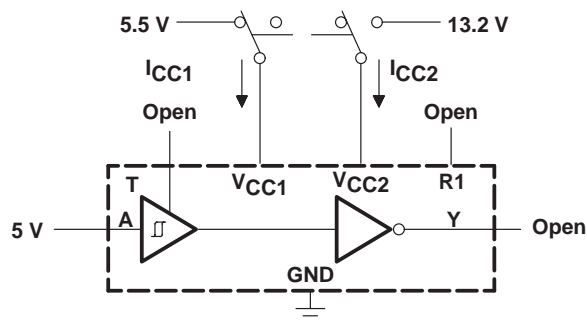
All four line receivers are tested simultaneously.

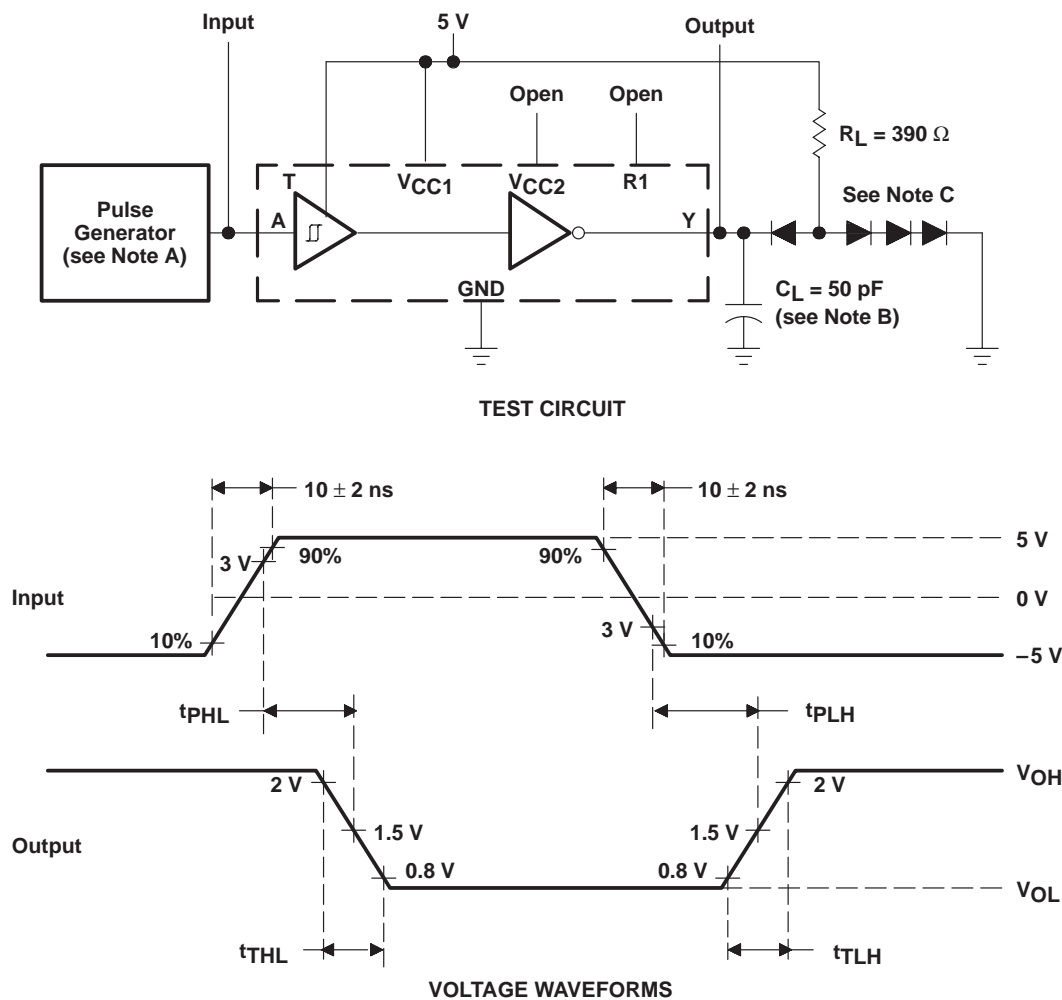**Figure 6. Supply Current**

† Arrows indicate actual direction of current flow. Current into a terminal is a positive value.

PARAMETER MEASUREMENT INFORMATION

TEST CIRCUIT

VOLTAGE WAVEFORMS

NOTES: A. The pulse generator has the following characteristics: $Z_O = 50\ \Omega$, $t_w \leq 200$ ns, duty cycle $\leq 20\%$.
       B. C_L includes probe and jig capacitance.
       C.   All diodes are 1N3064.

Figure 6. Test Circuit and Voltage Waveforms

PACKAGING INFORMATION

Orderable Device	Status [1]	Package Type	Package Drawing	Pins	Package Qty	Eco Plan [2]	Lead/Ball Finish	MSL Peak Temp [3]
SN75154D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75154DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75154DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75154DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75154N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN75154NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN75154NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75154NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

[1] The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

[2] Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

[3] MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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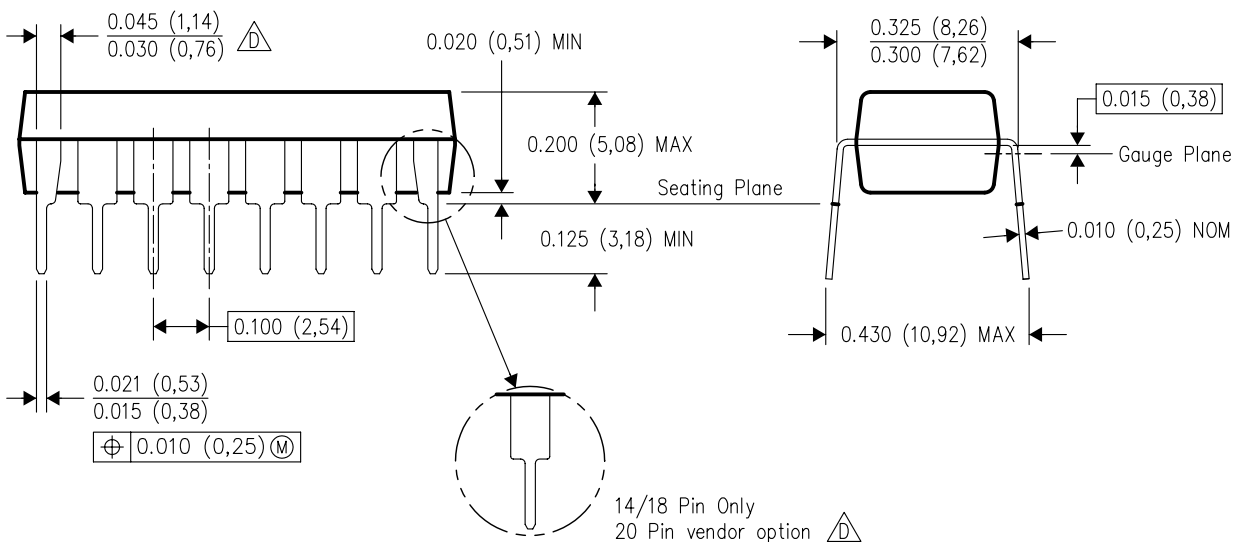
N (R-PDIP-T**) PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN
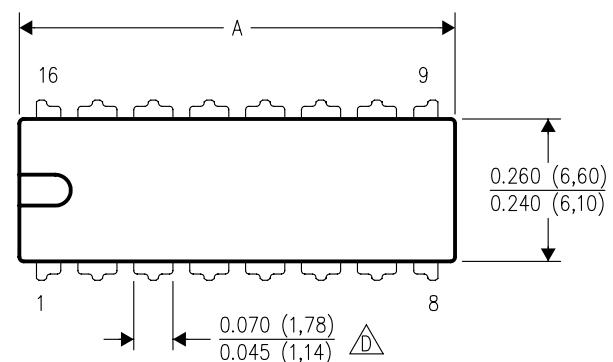
PINS ** DIM	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS-001 VARIATION	AA	BB	AC	AD

0.260 (6,60) / 0.240 (6,10)

0.070 (1,78) / 0.045 (1,14)

0.045 (1,14) / 0.030 (0,76)

0.020 (0,51) MIN

0.200 (5,08) MAX

Seating Plane

0.125 (3,18) MIN

0.100 (2,54)

0.021 (0,53) / 0.015 (0,38)

0.010 (0,25) M

14/18 Pin Only
20 Pin vendor option

0.325 (8,26) / 0.300 (7,62)

0.015 (0,38)

Gauge Plane
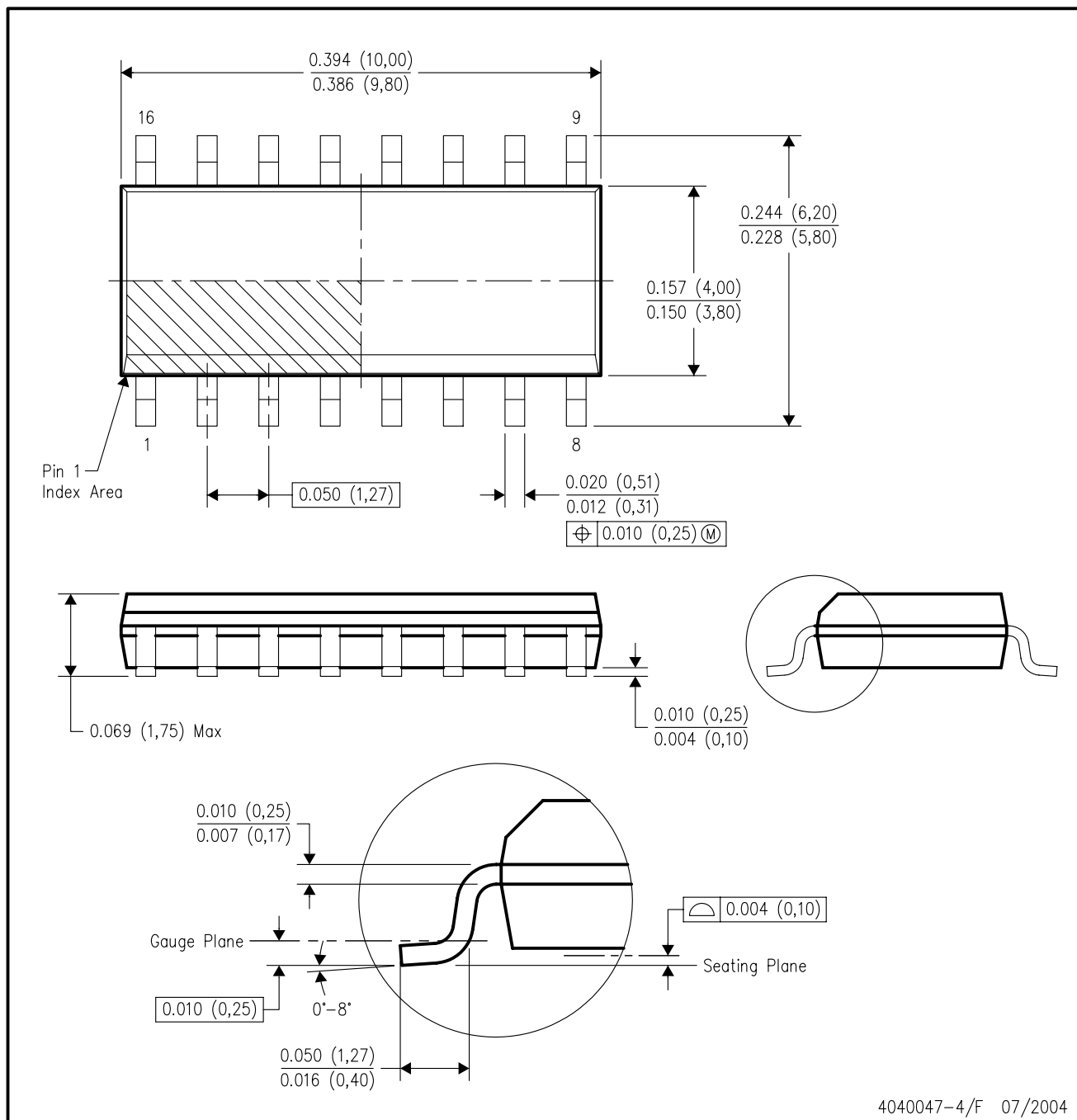
0.010 (0,25) NOM

0.430 (10,92) MAX

4040049/E 12/2002

NOTES: A. All linear dimensions are in inches (millimeters).
        B. This drawing is subject to change without notice.
        C. Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
        D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

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D (R−PDSO−G16) PLASTIC SMALL−OUTLINE PACKAGE

0.394 (10,00)
0.386 (9,80)

16   9

0.244 (6,20)
0.228 (5,80)

0.157 (4,00)
0.150 (3,80)

1   8

Pin 1
Index Area

0.050 (1,27)

0.020 (0,51)
0.012 (0,31)

⊕ 0.010 (0,25) Ⓜ

0.069 (1,75) Max

0.010 (0,25)
0.004 (0,10)

0.010 (0,25)
0.007 (0,17)

⌂ 0.004 (0,10)

Gauge Plane

Seating Plane

0.010 (0,25)   0°−8°

0.050 (1,27)
0.016 (0,40)

4040047−4/F   07/2004

NOTES: A.   All linear dimensions are in inches (millimeters).
         B.   This drawing is subject to change without notice.
         C.   Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
         D.   Falls within JEDEC MS−012 variation AC.

MECHANICAL DATA

PINS ** DIM	14	16	20	24
A MAX	10,50	10,50	12,90	15,30
A MIN	9,90	9,90	12,30	14,70

4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.
         B. This drawing is subject to change without notice.
         C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

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